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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

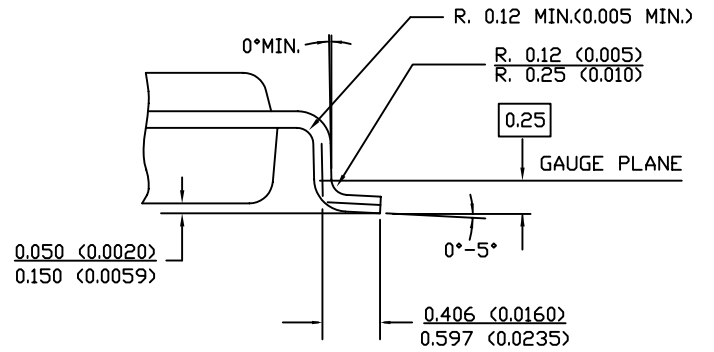
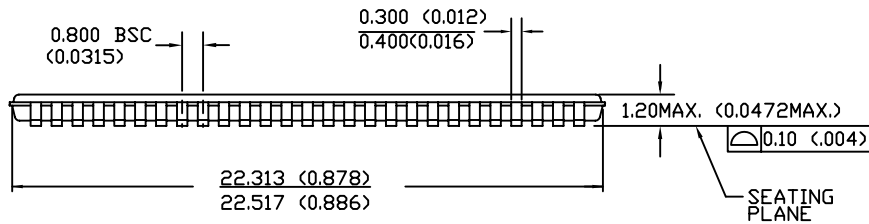
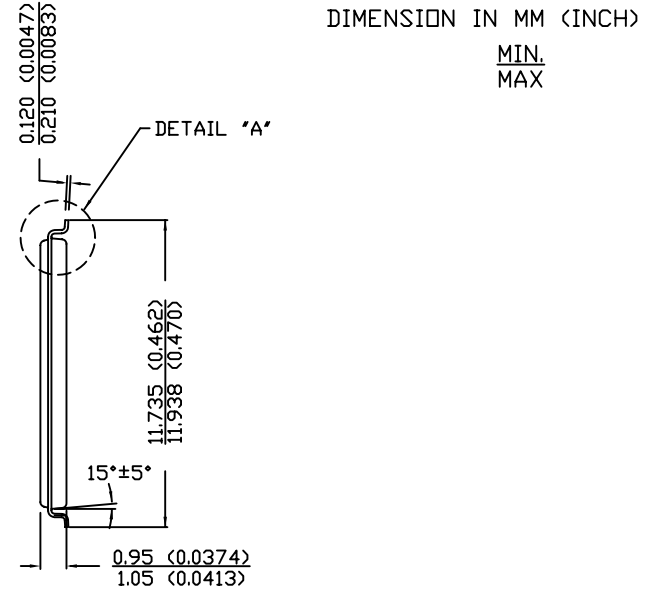
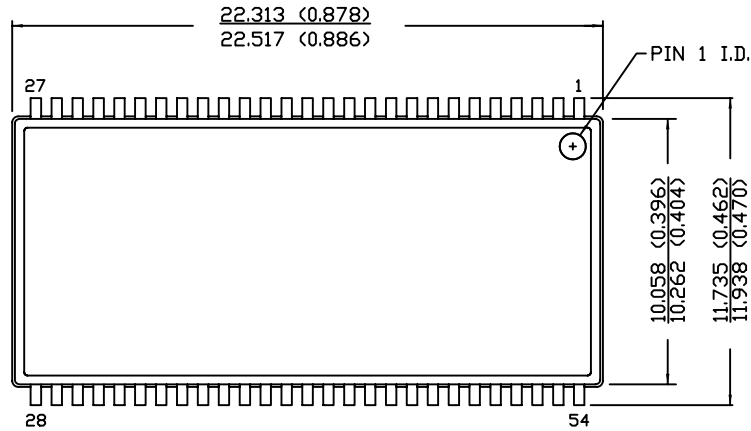
Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

54 Lead TSOP TYPE II – STANDARD



DETAIL "A"



TITLE
PACKAGE OUTLINE, 54LD TSOP II 22.4X11.84X1.0 MM Z54-II

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MATERIAL	N/A	DRAWN BY	HTN	DATE	02/21/02	SIZE	A	PART NO.	Z54-II	DWG NO.	51-85160	REV	*E
FINISH	N/A	APPROVED BY	QAD	DATE	08/08/14	SCALED TO FIT					SHEET 1 OF 2		

REV	ECN	ORIGIN OF CHANGE	DESCRIPTION OF CHANGE
**	113638	TSV	NEW RELEASE
*A	2872749	TZWTMP2	Changed Template and Title from 54LD TSOP II PKG OUTLINE to PACKAGE OUTLINE, 54LD TSOP II 22.4X11.84X1.0 MM Z54-II.
*B	3314383	QADTMP1	NO CHANGE. SUNSET REVIEW.
*C	3328432	QADTMP1	MINOR CHANGE : Corrected the Rev. B from B to *B.
*D	3690870	XANC	No Change. Sunset Review.
*E	4464649	XANC	For sunset review. Updated drawing template.



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MATERIAL	N/A	DRAWN BY	CS	DATE	7/23/12
FINISH	N/A	APPROVED BY	BSC	DATE	7/23/12

SIZE	PART NO.	DWG NO	REV
A	Z54-II	51-85160	*E
SCALED TO FIT			SHEET 2 OF 2